

**N - CHANNEL ENHANCEMENT MODE
POWER MOS TRANSISTOR**

TYPE	V _{DSS}	R _{DS(on)}	I _D
BUZ72A	100 V	0.25 Ω	9 A

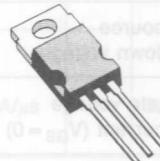
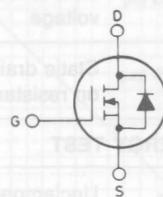
- 100 VOLTS - FOR UPS APPLICATIONS
- ULTRA FAST SWITCHING
- RATED FOR UNCLAMPED INDUCTIVE SWITCHING (ENERGY TEST) ♦
- EASY DRIVE - FOR REDUCED SIZE AND COST

INDUSTRIAL APPLICATIONS:

- UNINTERRUPTIBLE POWER SUPPLIES
- MOTOR CONTROLS

N - channel enhancement mode POWER MOS field effect transistor. Easy drive and very fast switching times make this POWER MOS transistor ideal for high speed switching application.

Typical applications include UPS, battery changers, printer hammer drivers, solenoid drivers and motor control.


TO-220
**INTERNAL SCHEMATIC
DIAGRAM**

ABSOLUTE MAXIMUM RATINGS

V _{DS}	Drain-source voltage (V _{GS} = 0)	100	V
V _{DGR}	Drain-gate voltage (R _{GS} = 20 kΩ)	100	V
V _{GS}	Gate-source voltage	±20	V
I _D	Drain current (continuous) T _c = 25°C	9	A
I _{DM}	Drain current (pulsed)	36	A
P _{tot}	Total dissipation at T _c < 25°C	40	W
T _{stg}	Storage temperature	-55 to 150	°C
T _j	Max. operating junction temperature	150	°C
	DIN humidity category (DIN 40040)	E	
	IEC climatic category (DIN IEC 68-1)	55/150/56	

♦ Introduced in 1989 week 1

THERMAL DATA

		Maximum			
$R_{thj \cdot case}$	Thermal resistance junction-case		max	3.1	°C/W
$R_{thj \cdot amb}$	Thermal resistance junction-ambient		max	75	°C/W

ELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$ unless otherwise specified)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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OFF

$V_{(BR) DSS}$	Drain-source breakdown voltage	$I_D = 250 \mu\text{A}$	$V_{GS} = 0$	100			V
I_{DSS}	Zero gate voltage drain current ($V_{GS} = 0$)	$V_{DS} = \text{Max Rating}$				250	μA
I_{GSS}	Gate-body leakage current ($V_{DS} = 0$)	$V_{DS} = \text{Max Rating}$	$T_j = 125^\circ\text{C}$	1000		1000	μA
		$V_{GS} = \pm 20 \text{ V}$				± 100	nA

ON

$V_{GS \text{ (th)}}$	Gate threshold voltage	$V_{DS} = V_{GS}$	$I_D = 1 \text{ mA}$	2.1		4	V
$R_{DS \text{ (on)}}$	Static drain-source on resistance	$V_{GS} = 10 \text{ V}$	$I_D = 5 \text{ A}$			0.25	Ω

ENERGY TEST

I_{UIS}	Unclamped inductive switching current (single pulse)	$V_{DD} = 30 \text{ V}$ starting $T_j = 25^\circ\text{C}$	$L = 100 \mu\text{H}$	9			A
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DYNAMIC

g_{fs}	Forward transconductance	$V_{DS} = 25 \text{ V}$	$I_D = 5 \text{ A}$	2.7			mho
C_{iss}	Input capacitance	$V_{DS} = 25 \text{ V}$				600	pF
C_{oss}	Output capacitance	$V_{GS} = 0$	$f = 1 \text{ MHz}$			240	pF
C_{rss}	Reverse transfer capacitance					130	pF

SWITCHING

$t_d \text{ (on)}$	Turn-on time	$V_{DD} = 30 \text{ V}$	$I_D = 2.9 \text{ A}$	30		ns
t_r	Rise time	$R_{GS} = 50 \Omega$	$V_{GS} = 10 \text{ V}$	70		ns
$t_d \text{ (off)}$	Turn-off delay time			90		ns
t_f	Fall time			70		ns

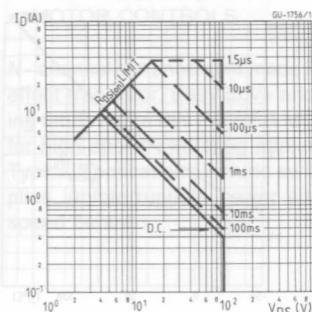
ELECTRICAL CHARACTERISTICS (Continued)

Parameters	Test Conditions	Min.	Typ.	Max.	Unit
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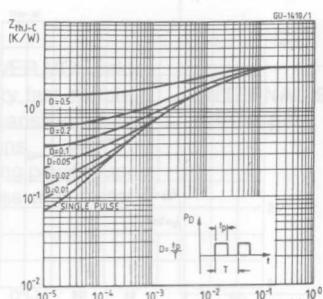
SOURCE DRAIN DIODE

I_{SD} I_{SDM}	Source-drain current Source-drain current (pulsed)	$T_c = 25^\circ C$		9 36	A A
V_{SD}	Forward on voltage	$I_{SD} = 18 A$	$V_{GS} = 0$	2	V
t_{rr} Q_{rr}	Reverse recovery time Reverse recovered charge	$I_{SD} = 9 A$	$dI/dt = 100 A/\mu s$	170 0.30	ns μC

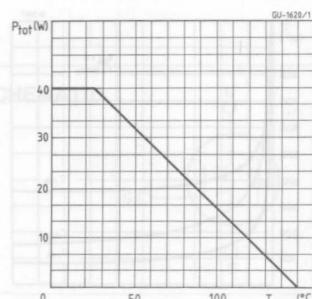
Safe operating areas



Thermal impedance

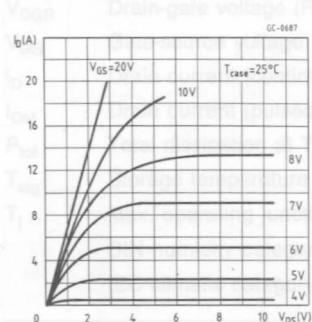


Derating curve

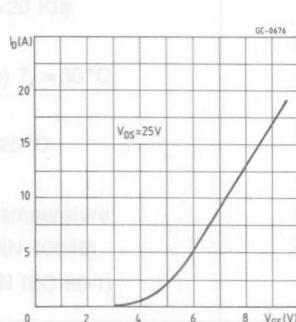


ABSOLUTE MAXIMUM RATINGS

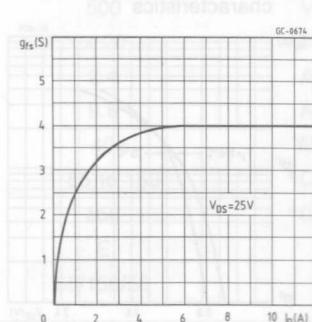
Output characteristics



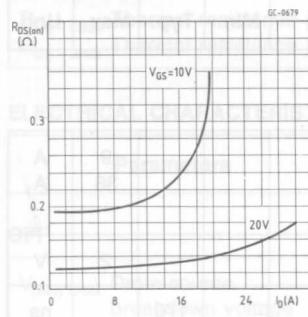
Transfer characteristics



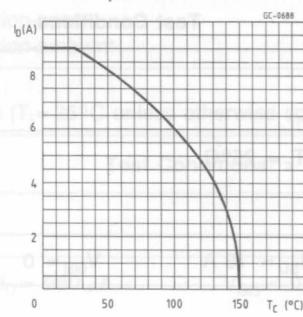
Transconductance



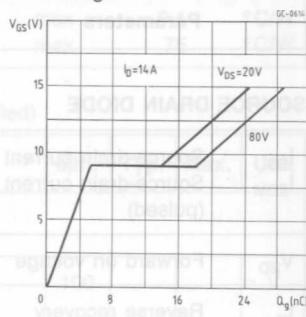
Static drain-source on resistance



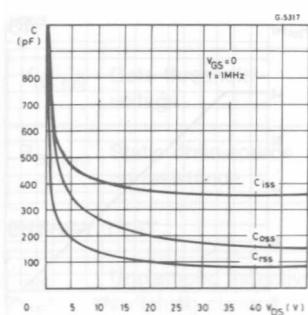
Maximum drain current vs temperature



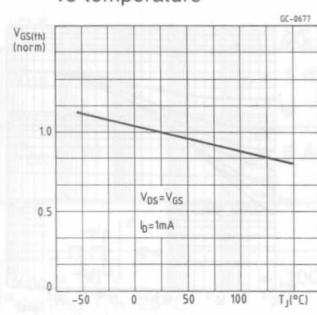
Gate charge vs gate-source voltage



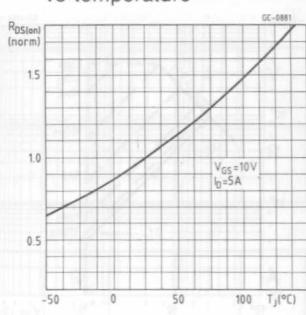
Capacitance variation



Gate threshold voltage vs temperature



Drain-source on resistance vs temperature



Source-drain diode forward characteristics

